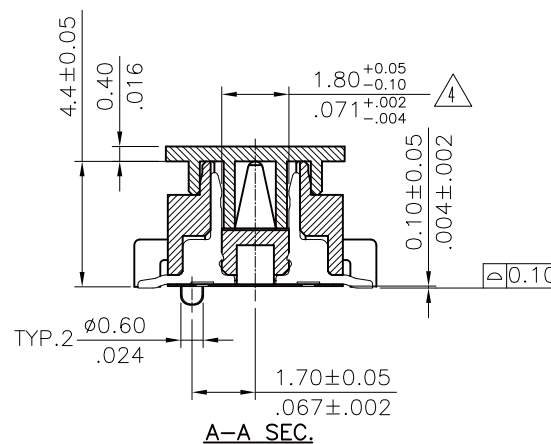
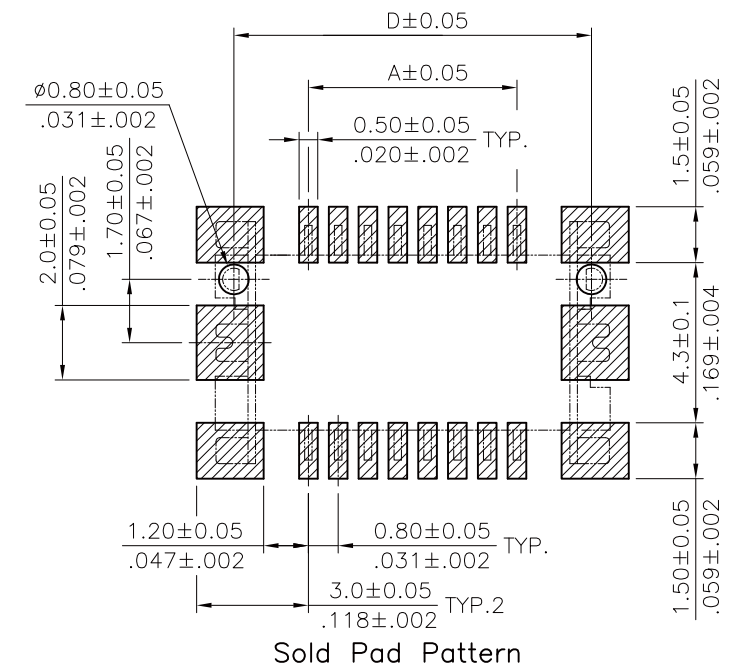


* Available in 10,12,14,16,20,24,26, 30,34,36,40,50,60,80 circuits



2. For Lead Free IR Reflow Process



DESCRIPTION:

- * Reel Material : HIPS
- * Carrier Material : Clear, Conductive Polystyrene Alloy
- * Cover Tape Material : Polyester
- * Cover Tape Peel Strength : 0.1N – 1.3N
- * Carrier camber is within 1mm in 100mm
- * All dimensions meet EIA-481-2 & EIA-481-3 requirements.

